

DZ2J300×0L

Silicon epitaxial planar type

For constant voltage / For surge absorption circuit

■ Features

- Excellent rising characteristics of zener current I_Z
- Low zener operating resistance R_Z
- Halogen-free / RoHS compliant
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: GG or GR

■ Packaging

Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Repetitive peak forward current	IFRM	200	mA
Total power dissipation ^{*1}	PT	200	mW
Electrostatic discharge ^{*2}	ESD	±8	kV
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note) *1 Mounted on glass epoxy print board (45 mm × 45 mm × 1 mm)

Solder in (Recommended land pattern)

*2 Test method : IEC61000_4_2

(C = 150 pF, R = 330 Ω, Contact discharge : 10 times)

■ Electrical Characteristics $T_a = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage ^{*1, *2}	VZ	IZ = 2 mA	28.50		31.50	V
Zener operating resistance	RZ	IZ = 2 mA			160	Ω
Zener rise operating resistance	RZK	IZ = 0.5 mA			160	Ω
Reverse current	IR	VR = 23 V			0.05	μA
Temperature coefficient of zener voltage ^{*3}	SZ	IZ = 2 mA		28.7		mV/°C

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 5 MHz.

3. *1 The temperature must be controlled 25 °C for VZ measurement.

VZ value measured at other temperature must be adjusted to VZ (25 °C).

*2 VZ guaranteed 20 ms after current flow

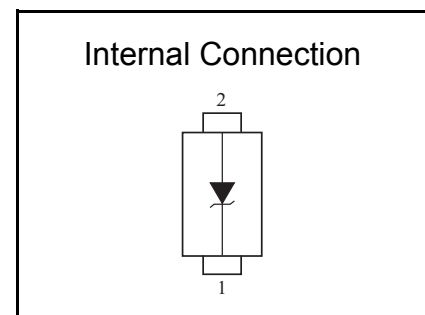
*3 Tj = 25 °C to 150 °C

Rank classification

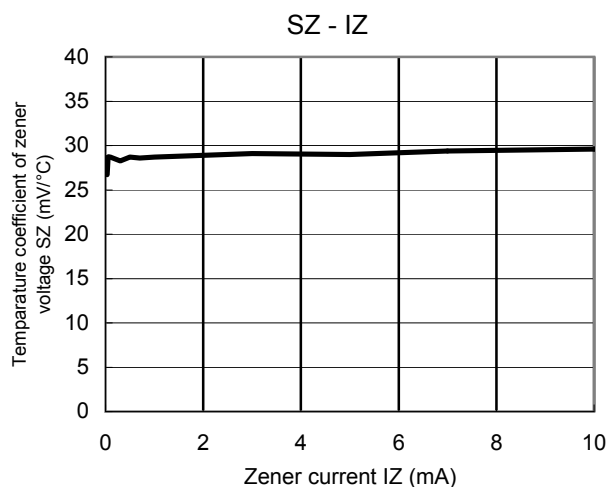
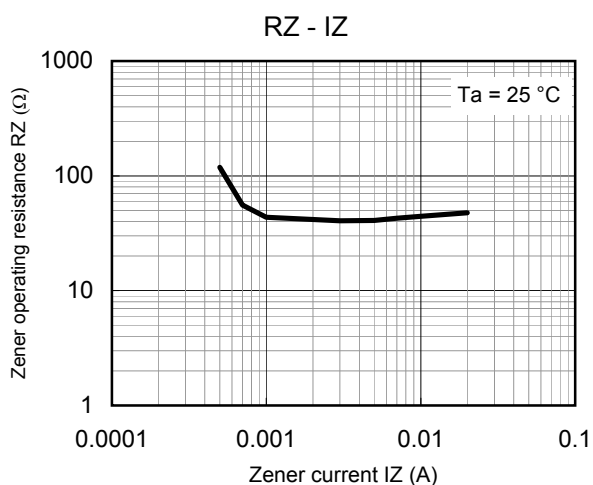
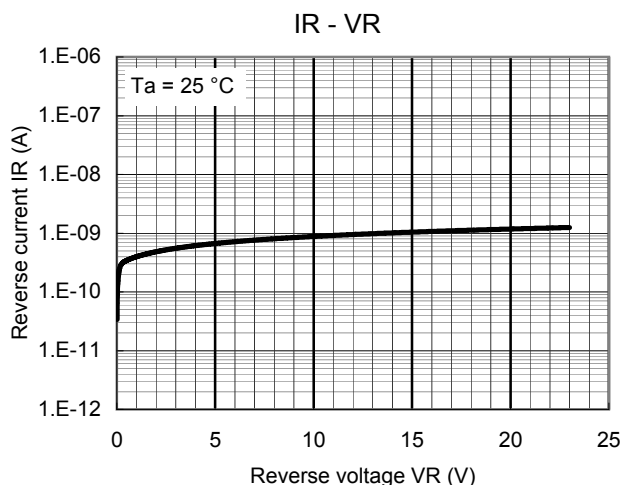
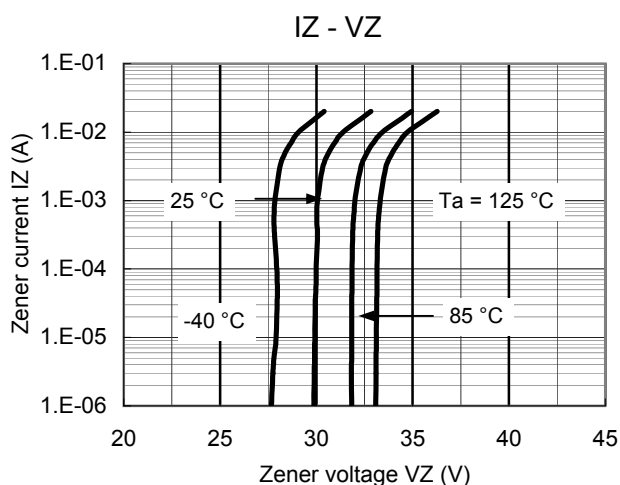
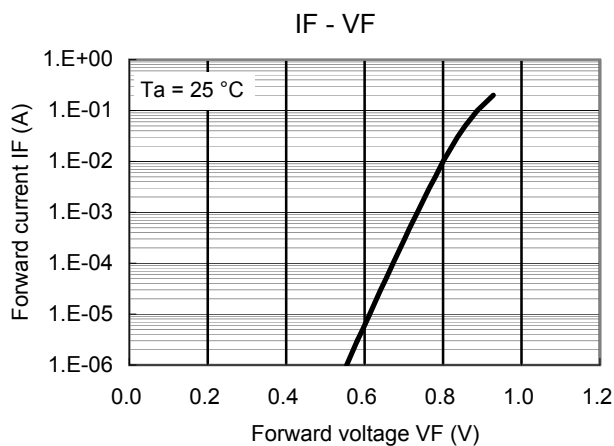
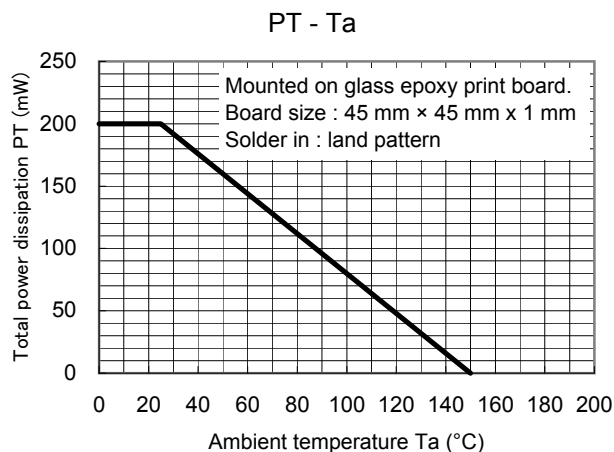
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Rank	M	No-rank
VZ	29.30 to 30.80	28.50 to 31.50
Marking symbol	GR	GG



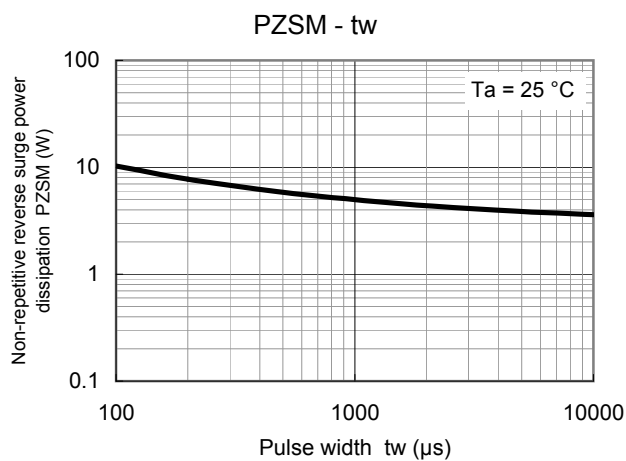
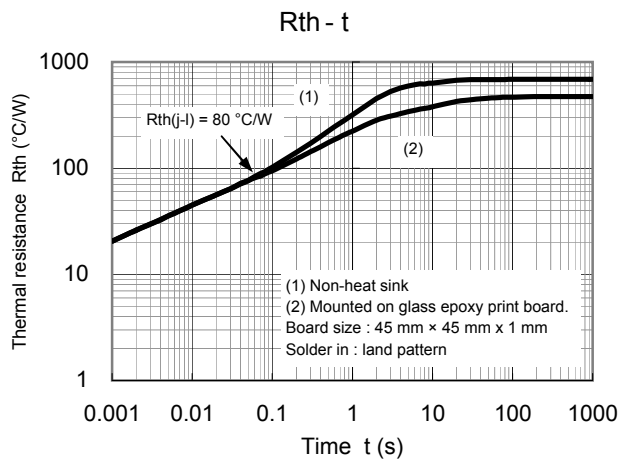
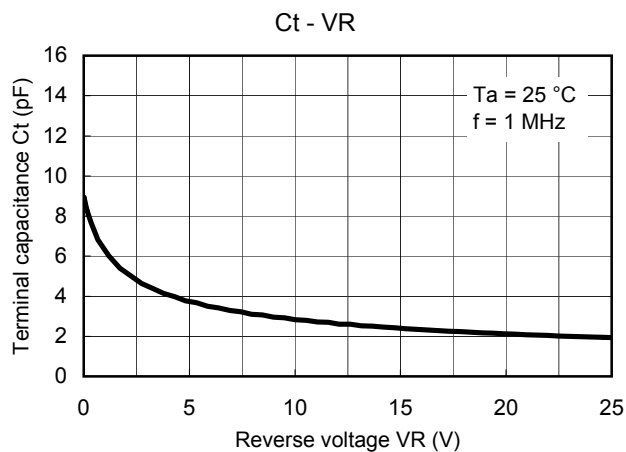
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JEITA	SC-90A
Code	—



Technical Data (reference)



Technical Data (reference)



Panasonic

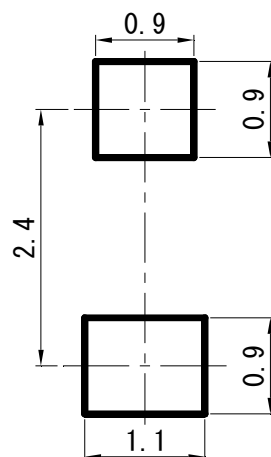
Zener Diode
DZ2J300×0L

SMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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